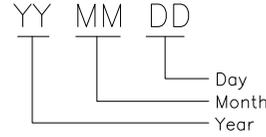
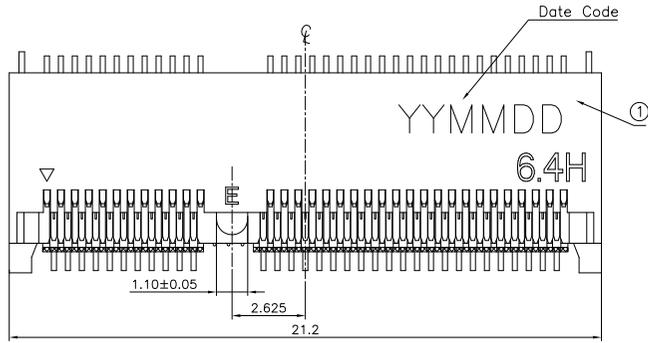


GP Component

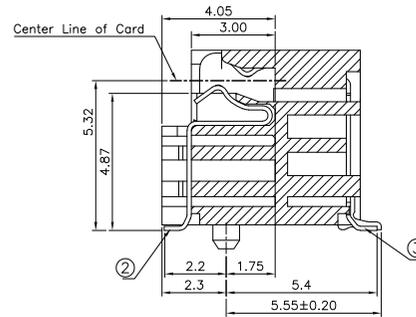
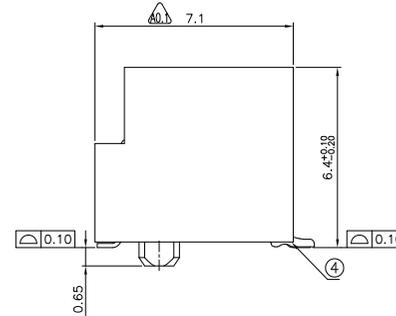
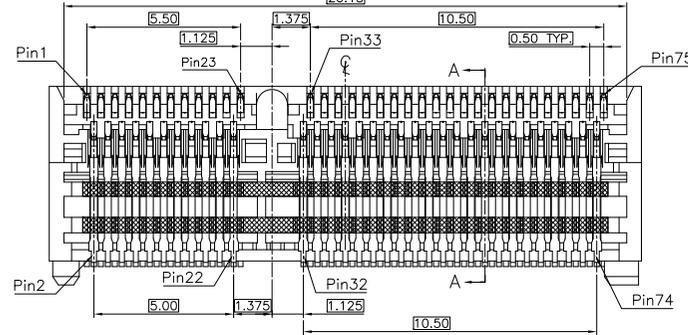
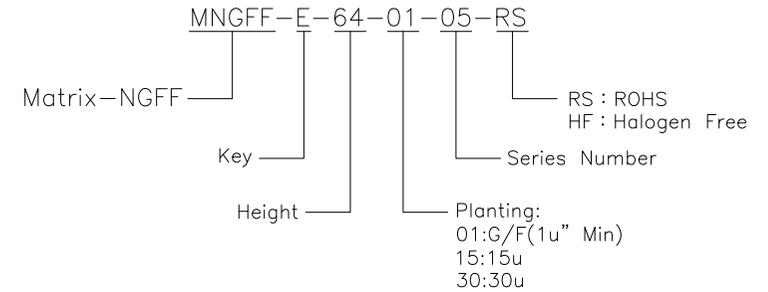
REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
AO			Initial	2015/07/03	Phebe Su
AO.1			Change	2023/09/08	Ken Lin



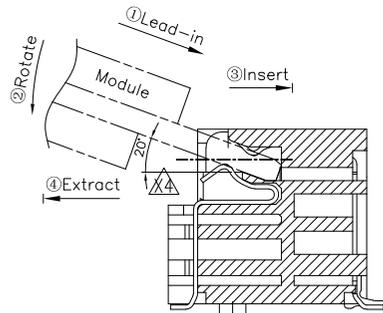
Notes:

- Materials
 - Housing: LCP+30% GF,UL94 V-0(E471i); BLACK
 - Contact: C5210-SH T=0.15mm, Mating area G/F(1u" Min.), Solder tail Matte Tin, 100u" Min. Matte Tin plating at solder tail, all over Nickel(50u" Min.);
 - LEG: C2680-EH T0.20mm, 100u" Min. Matte Tin plating over all, all over nickel(50u" Min.).
- RoHS 2.0 and HF compliant;
- Ratings
 - Voltage Rating: 50V AC (Per pin);
 - Current Rating: 0.5A (Per pin);
 - Operating Temperature: -40°C ~ 95°C;
- Electrical Requirement:
 - LLCR: 55mΩ Max.(Initial), 20mΩ Max. change allowed(Final);
 - Dielectric Withstanding Voltage: 300V AC (RMS) for 1 minute;
 - Insulation Resistance: 500MΩ Min. @ 500V DC;
- Mechanical Requirement:
 - Mating Force: 20N Max.;
 - Unmating Force: 20N Max.;
 - Durability: 60 Cycles;
 - Vibration: No electrical discontinuity greater than 1u sec shall occur;
 - Mechanical Shock: 285G half sine / 6 axis, No electrical discontinuity greater than 1u sec shall occur;
- Resistance to heat: the temperature shall be 260±5°C 10±1 seconds.

ORDER INFORMATION :



SECTION A-A



How to mate and unmate
Mate: ① - ② - ③
Unmate: ④

Matrix Electronics Co.,Ltd			
TOLERANCE: X:X ±0.20 X:XX ±0.10 X:XXX ±0.05 ANGLE: ±3°	DESIGN BY : Ken Lin	DATE : 2023/09/08	PART NAME: NGFF Socket (M.2 Connector) 6.4H, STD E key
UNIT: mm [inch]	CHECKED BY: Vicky Hsieh	DATE : 2023/09/08	PART NO. MNGFF-E-64-01-05-RS
SCALE:1:1	APPROVED BY1: Richard Hsieh	DATE : 2023/09/08	MOLD NO. NA
SIZE:A4	APPROVED BY2: Richard Hsieh	DATE : 2023/09/08	DRAW NO.
			SHEET NO. 1 OF 2

